

## DEGLARATION FOR NON-PROVISIONAL PATENT APPLICATION

. As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below at 201 et seq. beneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq. below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

#### ANNEALING PROCESS AND DEVICE OF SEMICONDUCTOR WAFER

and for which a patent application was filed in the United States on November 20, 2003 as Application No. 10/716,612.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

EARLIEST FOREIGN APPLIC	CATION(S), IF ANY, FILI	ED PRIOR TO THE FILING DA	TE OF THE AP	PLICATION
APPLICATION NUMBER	ER COUNTRY DATE OF FILING (day, month, year) PRIORITY CLAIMED			Y CLAIMED
0214864	France	27 November 2002	⊠ YES	□ NO
			□ YES	□ NO

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

PROVISIONAL APPLICATION NUMBER	FILING DATE

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose information known to me which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

NON-PROVISIONAL	EU DIC DATE	STATUS		
APPLICATION NO.	FILING DATE	PATENTED	PENDING	ABANDONED

<sup>\*</sup> for use only when the application is assigned to a company, partnership or other organization.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

				<del></del>	
	FULL NAME OF	LAST NAME	FIRST NAME	MIDDLE NAME	
2	INVENTOR	SCHWARZENBACH	Walter	<u>.</u>	
0	RESIDENCE &			ISHIP	
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1	POST OFFICE	STREET	CITY	STATE OR COUNTRY	ZIP CODE
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		SIGNATURE OF Walter SCHWA	RZENBACH	DATE	
			08/01	109	
	FULL NAME OF	LAST NAME	FIRST NAME	MIDDLE NAME	
2	INVENTOR	WAECHTER	Jean-Marc		i
	RESIDENCE &	СІТҮ	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZEN	ISHIP
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		SIGNATURE OF Jean-Marc WAE	о9/ <b>%</b>	lo <b>g</b>	
2	FULL NAME OF INVENTOR	LAST NAME	FIRST NAME	MIDDLE NAME	
0	RESIDENCE & CITIZENSHIP	CITY	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZEN	SHIP
3	POST OFFICE ADDRESS	STREET ·	СПУ	STATE OR COUNTRY	ZIP CODE
		SIGNATURE OF		DATE	•

In re Application of: Walter SCHWARZENBACH et al. Confirmation No.: 7150

Application No.: 10/716,612 Group Art Unit: 1742

Filing Date: November 20, 2003 Examiner:

For: ANNEALING PROCESS AND DEVICE OF Attorney Docket No.: 4717-7700

SEMICONDUCTOR WAFER

# POWER OF ATTORNEY BY ASSIGNEE AND EXCLUSION OF INVENTOR(S) UNDER 37 C.F.R. 3.71

### MS PATENT APPLICATION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The undersigned assignee of the entire interest in the above-identified subject application hereby appoints Allan A. Fanucci (Reg. No. 30,256) and Daniel J. Hulseberg (Reg. No. 36,554) of WINSTON & STRAWN LLP (Customer No. 28765) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith.

Please direct all correspondence for this application to Customer No. 28765 to the attention of Allan A. Fanucci (telephone 212-294-3311, facsimile 212-294-4700).

An assignment of the entire interest in the above-identified subject application is submitted herewith for recording and a copy is attached.

The undersigned has reviewed this assignment and, to the best of his/her knowledge, title is in the assignee seeking to take action in this application and that he/she is empowered to act on its behalf.

ASSIGNEE:	S.O.I. TEC SILICON ON INSULATOR TECHNOLOGIES S.A.
Signature:	Mee
Date of Signature:	Jan 00/09
Typed Name:	Emmanuel Huyghe
i ypeu ivaille.	Elimianuel Huygne
Position/Title:	Intellectual Property Manager
Address:	Parc Technologique des Fontaines
	38926 Bernin, France



### **ASSIGNMENT**

WHEREAS, each of

Walter SCHWARZENBACH, a citizen of France, residing at 19, Chemin du Mollard - 38330 Saint Nazaire les Eymes, France, and

Jean-Marc WAECHTER, a citizen of France, residing at Rue des Vignes - 38660 Saint Vincent de Mercuze, France,

ASSIGNOR, is an inventor of the invention in ANNEALING PROCESS AND DEVICE OF SEMICONDUCTOR WAFER, for which an application for a Patent of the United States, identified by Winston & Strawn LLP Docket No. 4717-7700, was filed on November 20, 2003 as Application No. 10/716,612.

WHEREAS, S.O.I.TEC SILICON ON INSULATOR TECHNOLOGIES S.A., a French corporate body having a place of business at Parc Technologique des Fontaines, 38190 Bernin, France, ASSIGNEE, is desirous of obtaining each inventor's entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to each inventor in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, each ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, his or her entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries other than the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

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And each ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

And each ASSIGNOR hereby covenants and agrees that he or she has the full right to convey the entire interest herein assigned, and that he or she has not executed, and will not execute, any agreement in conflict herewith;

And each ASSIGNOR hereby further covenants and agrees that he or she will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to him or her respecting said invention, testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE or, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries;

And each ASSIGNOR hereby authorizes the ASSIGNEE's patent attorney to complete this form by the addition of the application number, application filing date, and attorney docket number, if necessary.

In witness whereof, each inventor has affixed his or her signature.

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Date				Walter SC	HWARZENBACH
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	ame, wh				and known to be to be the person on a nowledged the same to be his free a
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Witness

January ogth Date	Jean-Marc WAECHTER
appeared Jean-Marc WAECE	day of \( \sqrt{200\format{g}}\), 200\formath{g}\), before me personally HTER, to me known and known to be to be the person of that ag instrument and acknowledged the same to be his free act and
	E. HUYGHE
	Witness